

Ordering Information

Part Number	Ambient Temperature Range	Package	Environmental
AOZ8206DI-05	-40°C to +85°C	DFN 1.6x1.6_6L	Green Product RoHS Compliant



AOS Green Products use reduced levels of Halogens, and are also RoHS compliant.

Please visit www.aosmd.com/web/quality/rohs_compliant.jsp for additional information.

Absolute Maximum Ratings

Exceeding the Absolute Maximum ratings may damage the device.

Parameter	Rating
Peak Pulse Current (I _{PP}), t _P = 8/20µs	5A
Storage Temperature (T _S)	-65°C to +150°C
ESD Rating per IEC61000-4-2, Contact ⁽¹⁾	±20kV
ESD Rating per IEC61000-4-2, Air ⁽¹⁾	±20kV
ESD Rating per Human Body Model ⁽²⁾	±20kV

Notes:

1. IEC 61000-4-2 discharge with C_{Discharge} = 150pF, R_Discharge = 330 Ω .

2. Human Body Discharge per MIL-STD-883, Method 3015 $C_{Discharge} = 100 pF$, $R_{Discharge} = 1.5 k\Omega$.

Maximum Operating Ratings

Parameter	Rating
Junction Temperature (T _J)	-40°C to +125°C

Electrical Characteristics

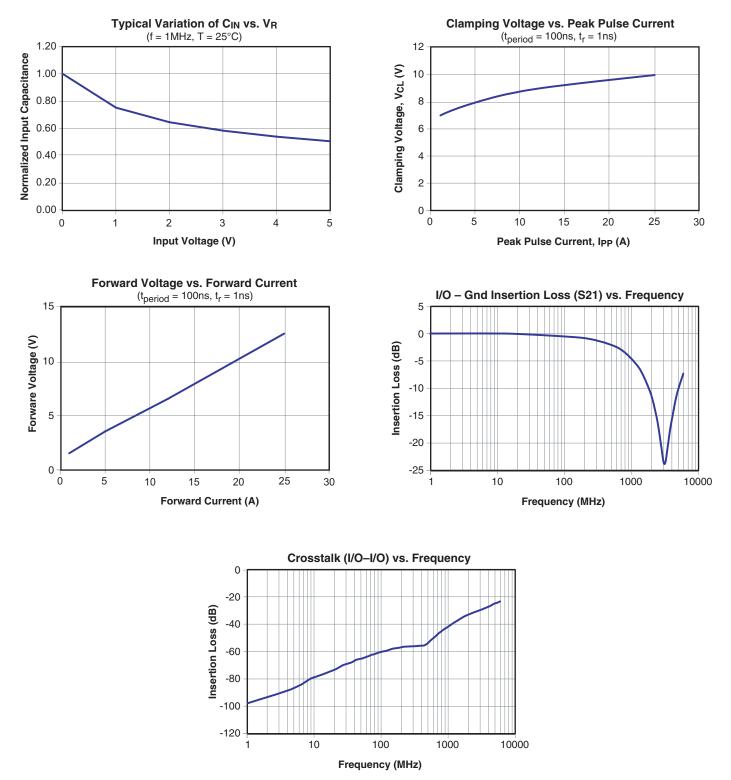
 $T_A = 25^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Diagram
I _{PP}	Maximum Reverse Peak Pulse Current	
V _{CL}	Clamping Voltage @ I _{PP}	
V _{RWM}	Working Peak Reverse Voltage	IF
I _R	Maximum Reverse Leakage Current	
V _{BR}	Breakdown Voltage	
١ _F	Forward Current	V
V _F	Forward Voltage	
P _{PK}	Peak Power Dissipation	
CJ	Max. Capacitance @ $V_R = 0$ and f = 1MHz	I Ipp

	Device	V _{RWM} (V)	V _{BR} (V)	I _R (μΑ)	V _F (V)		V _{CL} Max.	С _{.)} (рF)	
Device	Marking	Max.	Min.	Max.	Тур.	I _{PP} = 1A	I _{PP} = 5A	I _{PP} = 12A	Max.
AOZ8206DI-05	С	5	6.0	0.1	0.85	7.0	8.0	9.0	17



Typical Performance Characteristics



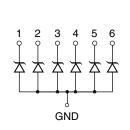


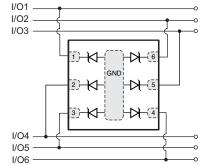
Applications Information

Device Connection for Protection of Six Unidirectional Data Lines

These devices are designed to protect up to six unidirectional data lines. The device is connected as follows.

 Unidirectional protection of six I/O lines is achieved by connecting pins 1, 2, 3, 4, 5 and 6 to the data lines. The ground connection should be made directly to the ground plane for best results. The path length is kept as short as possible to reduce the effects of parasitic inductance in the board traces.





Circuit Diagram

Protection of Six Unidirection Lines

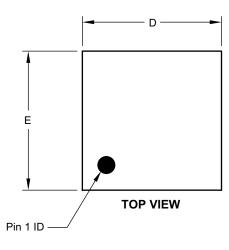
Circuit Board Layout Recommendations for Suppression of ESD

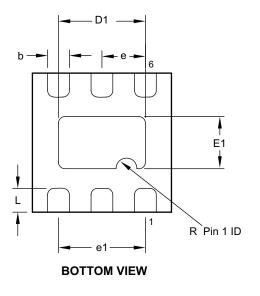
Good circuit board layout is critical for the suppression of ESD induced transients. The following guidelines are recommended:

- Place the TVS near the input terminals or connectors to restrict transient coupling.
- Minimize the path length between the TVS and the protected line.
- Minimize all conductive loops including power and ground loops.
- The ESD transient return path to ground should be kept as short as possible.
- Never run critical signals near board edges.
- Use ground planes whenever possible.



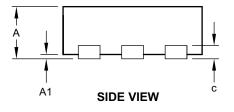
Package Dimensions, DFN 1.6mm x 1.6mm





Dimensions in millimeters

Symbols	Min.	Nom.	Max.		
А	0.50	0.55	0.60		
A1	0.00	0.02	0.05		
b	0.22	0.25	0.28		
С	1	.52 REF			
D	1.55	1.60	1.65		
D1	0.95	1.00	1.05		
Е	1.55	1.60	1.65		
E1	0.55	0.60	0.65		
е	0.50 BSC				
e1	1.0 REF				
L	0.225	0.275	0.325		
R		0.20			



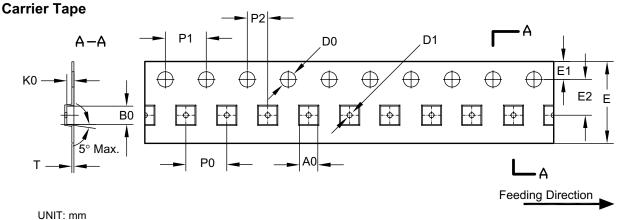
Notes:

1. Dimensions and tolerancing conform to ASME Y14.5M-1994.

2. All dimensions are in millimeters.

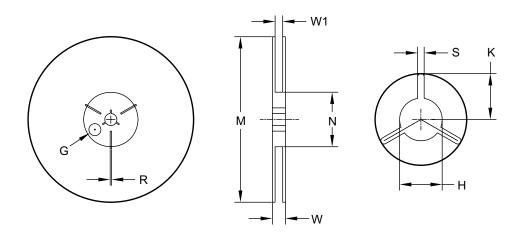


Tape and Reel Dimensions, DFN 1.6mm x 1.6mm



Package	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	Т
DFN 1.6x1.6	1.78	1.78	0.69	ø1.50	ø0.50	8.00	1.75	3.50	4.00	4.00	2.00	0.20
	±0.05	±0.05	±0.05	±0.10	±0.05	+0.30 / -0.10	±0.10	±0.05	±0.10	±0.10	±0.05	±0.02

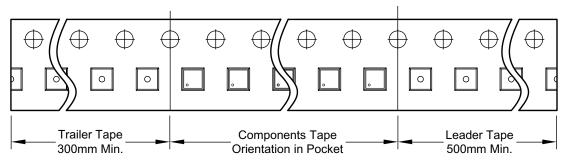
Reel



UNIT: mm

Tape Size	Reel Size	М	Ν	w	W1	Н	S	к	E	R
8mm	ø178	ø178.0 ±1.0	ø60.0 ±1.0	11.80 ±0.5	9.0 ±0.5	ø13.0 +0.5 / –0.2	2.40 ±0.10	10.25 ±0.2	ø9.8	—

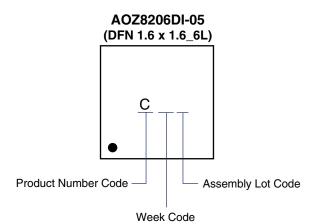
Leader / Trailer & Orientation



Rev. 1.4 April 2010



Package Marking





Revision History

Revision	Revised Item
Rev. 1.3	Initial release
Rev. 1.4	Package marking information added

This data sheet contains preliminary data; supplementary data may be published at a later date. Alpha & Omega Semiconductor reserves the right to make changes at any time without notice.

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